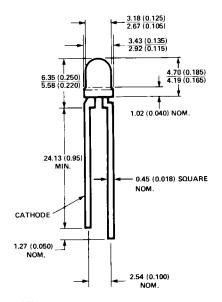


HLMP-132x Series, HLMP-142x Series, HLMP-152x Series

Description

This family of T-1 lamps is specially designed for applications requiring higher on-axis intensity than is achievable with a standard lamp. The light generated is focused to a narrow beam to achieve this effect.

Package Dimensions



NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETRES (INCHES).

2. AN EPOXY MENISCUS MAY EXTEND ABOUT 1mm (0.040") DOWN THE LEADS.

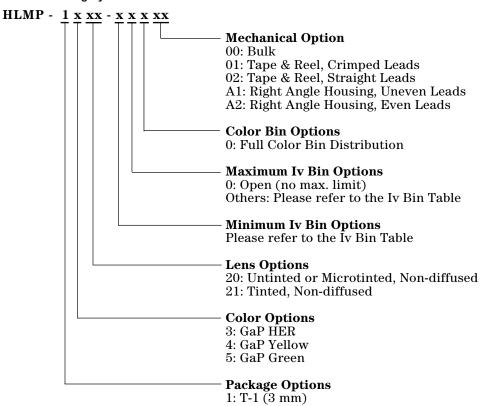
Selection Guide

Part Number	Package Description	Color	Luminous Iv (mcd) (Min.	•
HLMP-1320-G00xx	Untinted,		8.6	-
HLMP-1320 GH0xx	Nondiffused	High	8.6	27.6
HLMP-1321	Tinted,	Efficiency Red	8.6	-
HLMP-1321-G00xx	Nondiffused	Neu	8.6	-
HLMP-1321-HI0xx			13.8	44.0
HLMP-1420	Microtinted,		9.2	-
HLMP-1420-F00xx	Nondiffused		9.2	-
HLMP-1421		Yellow	9.2	-
HLMP-1421-F00xx	Tinted, Nondiffused		9.2	-
HLMP-1421-FG0xx	Worldingsed		9.2	29.4
HLMP-1520	Microtinted,		6.7	-
HLMP-1520-E00xx	Nondiffused		6.7	-
HLMP-1521		Green	6.7	-
HLMP-1521-E00xx	Tinted, Nondiffused		6.7	-
HLMP-1521-EF0xx	Nonamuscu		6.7	21.2

Features

- · High intensity
- · Choice of 3 bright colors High Efficiency Red Yellow High Performance Green
- · Popular T-1 diameter package
- · Selected minimum intensities
- · Narrow viewing angle
- · General purpose leads
- · Reliable and rugged
- · Available on tape and reel
- · For more information, please refer to Tape and Reel Option data sheet

Part Numbering System



Absolute Maximum Ratings at T_A = 25°C

Parameter	Red	Yellow	Green	Units
Peak Forward Current	90	60	90	mA
Average Forward Current ^[1]	25	20	25	mA
DC Current ^[2]	30	20	30	mA
Power Dissipation ^[3]	135	85	135	mW
Reverse Voltage ($I_R = 100 \mu A$)	5	5	5	V
Transient Forward Current ^[4] (10 μsec Pulse)	500	500	500	mA
LED Junction Temperature	110	110	110	°C
Operating Temperature Range	-55 to +100	-55 to +100	-20 to +100	°C
Storage Temperature Range	_		-55 to +100	-

Notes

- 1. See Figure 5 (Red), 10 (Yellow), or 15 (Green) to establish pulsed operating conditions.
- 2. For Red and Green series derate linearly from 50°C at 0.5 mA/°C. For Yellow series derate linearly from 50°C at 0.2 mA/°C.
- 3. For Red and Green series derate power linearly from 25°C at 1.8 mW/°C. For Yellow series derate power linearly from 50°C at 1.6 mW/°C.
- 4. The transient peak current is the maximum non-recurring peak current that can be applied to the device without damaging the LED die and wirebond. It is not recommended that the device be operated at peak currents beyond the peak forward current listed in the Absolute Maximum Ratings.

$\underline{\text{Electrical Characteristics at T}_{A} = 25^{\circ}\text{C}}$

Symbol	Description	Device HLMP-	Min.	Тур.	Max.	Units	Test Conditions
Ι _V	Luminous Intensity	1320 1321	8.6 8.6	30 30		mcd	I _F = 10 mA (Figure 3)
		1420 1421	9.2 9.2	15 15		mcd	I _F = 10 mA (Figure 8)
		1520 1521	6.7 6.7	22 22		mcd	I _F = 10 mA (Figure 3)
$2\theta^1/2$	Including Angle Between Half Luminous Intensity Points	All		45		Deg.	I _F = 10 mA See Note 1 (Figures 6, 11, 16, 21)
λ_{PEAK}	Peak Wavelength	132x		635		nm	Measurement
		142X 152X		583 565			at Peak (Figure 1)
$\Delta \lambda_{1/2}$	Spectral Line Halfwidth	132x		40		nm	
		142X 152X		36 28			
$\lambda_{\sf d}$ Dominant Wave	Dominant Wavelength	132x		626		nm	See Note 2 (Figure 1)
		142X 152X		585 569			
$\overline{\iota_{S}}$	Speed of Response	132x		90		ns	
		142X 152X		90 500			
C Capacitance	Capacitance	132x		11		pF	V _F = 0; f = 1 MHz
		142X 152X		15 18			
$R\theta_{J-PIN}$	Thermal Resistance	All		290		°C/W	Junction to Cathode Lead
V_{F}	Forward Voltage	132x		1.9	2.4	V	I _F = 10 mA
		142X 152X		2.0 2.1	2.4 2.7		
$\overline{V_R}$	Reverse Breakdown Voltage	All	5.0			V	$I_R = 100 \mu\text{A}$
$\overline{\eta_{V}}$	Luminous Efficacy	132x		145		lumens	See Note 3
		142X 152X		500 595		watt	

Notes:

^{1.} $\theta^1/2$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

^{2.} The dominant wavelength, λ_d , is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

^{3.} Radiant intensity, I_e , in watts/steradian, may be found from the equation $I_e = I_V/\eta_V$, where I_V is the luminous intensity in candelas and η_V is the luminous efficacy in lumens/watt.

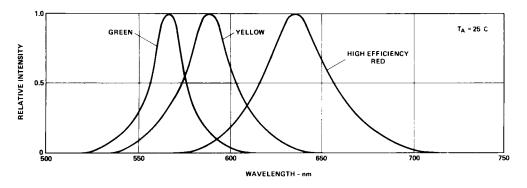


Figure 1. Relative intensity vs. wavelength.

T-1 High Efficiency Red Non-Diffused

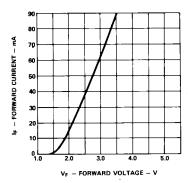


Figure 2. Forward current vs. forward voltage characteristics.

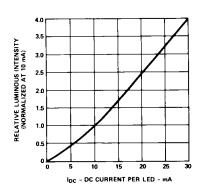


Figure 3. Relative luminous intensity vs. DC forward current.

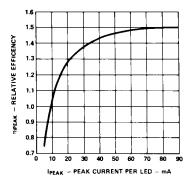


Figure 4. Relative efficiency (luminous intensity per unit current) vs. peak LED current.

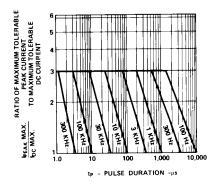


Figure 5. Maximum tolerable peak current vs. pulse duration. (I $_{\rm DC}$ MAX as per MAX ratings).

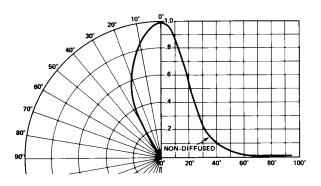
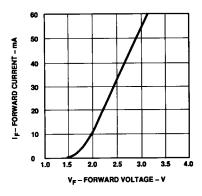
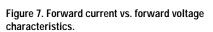


Figure 6. Relative luminous intensity vs. angular displacement.

T-1 Yellow Non-Diffused





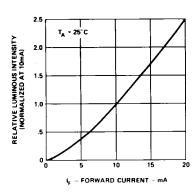


Figure 8. Relative luminous intensity vs. forward current.

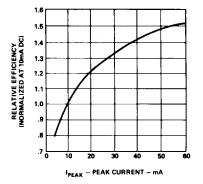


Figure 9. Relative efficiency (luminous intensity per unit current) vs. peak current.

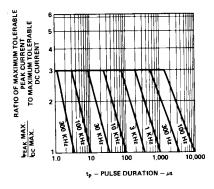


Figure 10. Maximum tolerable peak current vs. pulse duration. ($I_{DC}MAX$ as per MAX ratings).

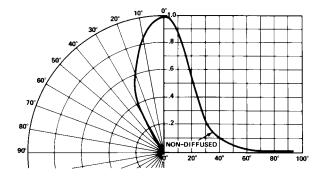


Figure 11. Relative luminous intensity vs. angular displacement.

T-1 Green Non-Diffused

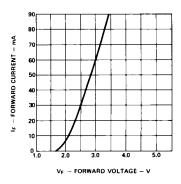


Figure 12. Forward current vs. forward voltage characteristics.

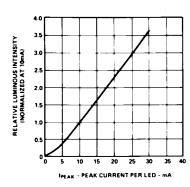


Figure 13. Relative luminous intensity vs. forward current.

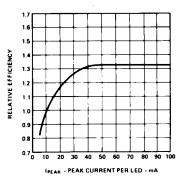


Figure 14. Relative efficiency (luminous intensity per unit current) vs. peak LED current.

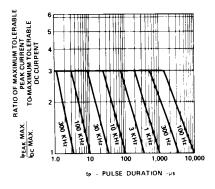


Figure 15. Maximum tolerable peak current vs. pulse duration. (I_{DCMAX} as per MAX ratings).

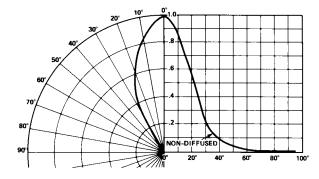


Figure 16. Relative luminous intensity vs. angular displacement.

Intensity Bin Limits

		Intensity Range (mcd)		
Color	Bin	Min.	Max.	
	G	9.7	15.5	
	Н	15.5	24.8	
	<u> 1 </u>	24.8	39.6	
	J	39.6	63.4	
	K	63.4	101.5	
	L	101.5	162.4	
	М	162.4	234.6	
	N	234.6	340.0	
	0	340.0	540.0	
Red	P	540.0	850.0	
	Q	850.0	1200.0	
	R	1200.0	1700.0	
	S	1700.0	2400.0	
	T	2400.0	3400.0	
	U	3400.0	4900.0	
	V	4900.0	7100.0	
	W	7100.0	10200.0	
	X	10200.0	14800.0	
	Υ	14800.0	21400.0	
	Z	21400.0	30900.0	
	F	10.3	16.6	
	G	16.6	26.5	
	Н	26.5	42.3	
	Ī	42.3	67.7	
	J	67.7	108.2	
	K	108.2	173.2	
	L	173.2	250.0	
Yellow	M	250.0	360.0	
	N	360.0	510.0	
	0	510.0	800.0	
	P	800.0	1250.0	
	Q	1250.0	1800.0	
	R	1800.0	2900.0	
	S	2900.0	4700.0	
	T	4700.0	7200.0	
	U	7200.0	11700.0	
	V	11700.0	18000.0	

Intensity Bin Limits

		Intensity Range (mcd)		
Color	Bin	Min.	Max.	
	E	7.6	12.0	
	F	12.0	19.1	
	G	19.1	30.7	
	Н	30.7	49.1	
	I	49.1	78.5	
	J	78.5	125.7	
	K	125.7	201.1	
	L	201.1	289.0	
Green	M	289.0	417.0	
	N	417.0	680.0	
	0	680.0	1100.0	
	P	1100.0	1800.0	
	Q	1800.0	2700.0	
	R	2700.0	4300.0	
	S	4300.0	6800.0	
	T	6800.0	10800.0	
	U	10800.0	16000.0	
	V	16000.0	25000.0	
	W	25000.0	40000.0	

Maximum tolerance for each bin limit is $\pm 18\%$.

Color Categories

		Lambda (nm)		
Color	Category #	Min.	Max.	
	6	561.5	564.5	
	5	564.5	567.5	
Green	4	567.5	570.5	
	3	570.5	573.5	
	2	573.5	576.5	
	1	582.0	584.5	
	3	584.5	587.0	
Yellow	2	587.0	589.5	
	4	589.5	592.0	
	5	592.0	593.0	

Maximum tolerance for each bin limit is ± 0.5 nm.

Mechanical Option Matrix

Mechanical Option Code	Definition
00	Bulk Packaging, minimum increment 500 pcs/bag
01	Tape & Reel, crimped leads, minimum increment 1800 pcs/bag
02	Tape & Reel, straight leads, minimum increment 1800 pcs/bag
A1	Right Angle Housing, uneven leads, minimum increment 500 pcs/bag
A2	Right Angle Housing, even leads, minimum increment 500 pcs/bag

Note:
All categories are established for classification of products. Products may not be available in all categories. Please contact your local Agilent representative for further clarification/information.

Precautions

Lead Forming

- The leads of an LED lamp may be preformed or cut to length prior to insertion and soldering into PC board.
- If lead forming is required before soldering, care must be taken to avoid any excessive mechanical stress induced to LED package. Otherwise, cut the leads of LED to length after soldering process at room temperature. The solder joint formed will absorb the mechanical stress of the lead cutting from traveling to the LED chip die attach and wirebond.
- It is recommended that tooling made to precisely form and cut the leads to length rather than rely upon hand operation.

Soldering Conditions

- Care must be taken during PCB assembly and soldering process to prevent damage to LED component.
- The closest LED is allowed to solder on board is 1.59 mm below the body (encapsulant epoxy) for those parts without standoff.
- Recommended soldering conditions:

	Wave Soldering	Manual Solder Dipping
Pre-heat Temperature	105 °C Max.	_
Pre-heat Time	30 sec Max.	_
Peak Temperature	250 °C Max.	260 °C Max.
Dwell Time	3 sec Max.	5 sec Max.

- Wave soldering parameter must be set and maintained according to recommended temperature and dwell time in the solder wave. Customer is advised to periodically check on the soldering profile to ensure the soldering profile used is always conforming to recommended soldering condition.
- If necessary, use fixture to hold the LED component in proper orientation with respect to the PCB during soldering process.
- Proper handling is imperative to avoid excessive thermal stresses to LED components when heated.
 Therefore, the soldered PCB must be allowed to cool to room temperature, 25°C, before handling.
- Special attention must be given to board fabrication, solder masking, surface plating and lead holes size and component orientation to assure solderability.
- Recommended PC board plated through hole sizes for LED component leads:

LED Component Lead Size	Diagonal	Plated Through Hole Diameter
0.457 x 0.457 mm	0.646 mm	0.976 to 1.078 mm
(0.018 x 0.018 inch)	(0.025 inch)	(0.038 to 0.042 inch)
0.508 x 0.508 mm	0.718 mm	1.049 to 1.150 mm
(0.020 x 0.020 inch)	(0.028 inch)	(0.041 to 0.045 inch)

Note: Refer to application note AN1027 for more information on soldering LED components.

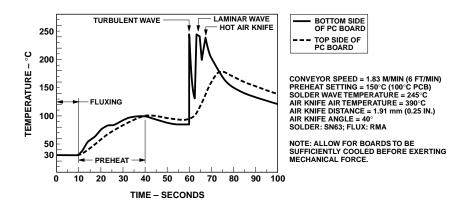


Figure 17. Recommended wave soldering profile.

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